

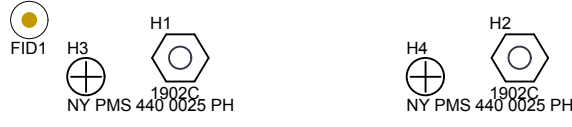
Notes:
 1. Built on PMP9256 printed circuit board.
 2. Reference designators greater than 100 are additional components that do not appear on the layout.

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Number: PMP10541	Rev: A	Designed for: Public Release	Mod. Date: 10/8/2014
SVN Rev: Version control disabled		Project Title: LM5122 Isolated Synchronous Flyback	
Drawn By: Robert Sheehan		Sheet Title: LM5122 Isolated Synchronous Flyback	
Engineer: Robert Sheehan		Assembly Variant: [No Variations]	Sheet: 1 of 2
		File: PMP10541_REVA.SchDoc	Size: B
		Contact: http://www.ti.com/support	



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PCB Number: PMP10541
PCB Rev: E1

PCB
LOGO
Texas Instruments



LBL1
PCB Label
Size: 0.65" x 0.20"


ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.

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SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Project Title: LM5122 Isolated Synchronous Flyback	Sheet: 2 of 2
Drawn By:	File: Hardware_ANSI-B.SchDoc	Contact: http://www.ti.com/support	Size: B
Engineer: Robert Sheehan	 http://www.ti.com © Texas Instruments 2013		

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